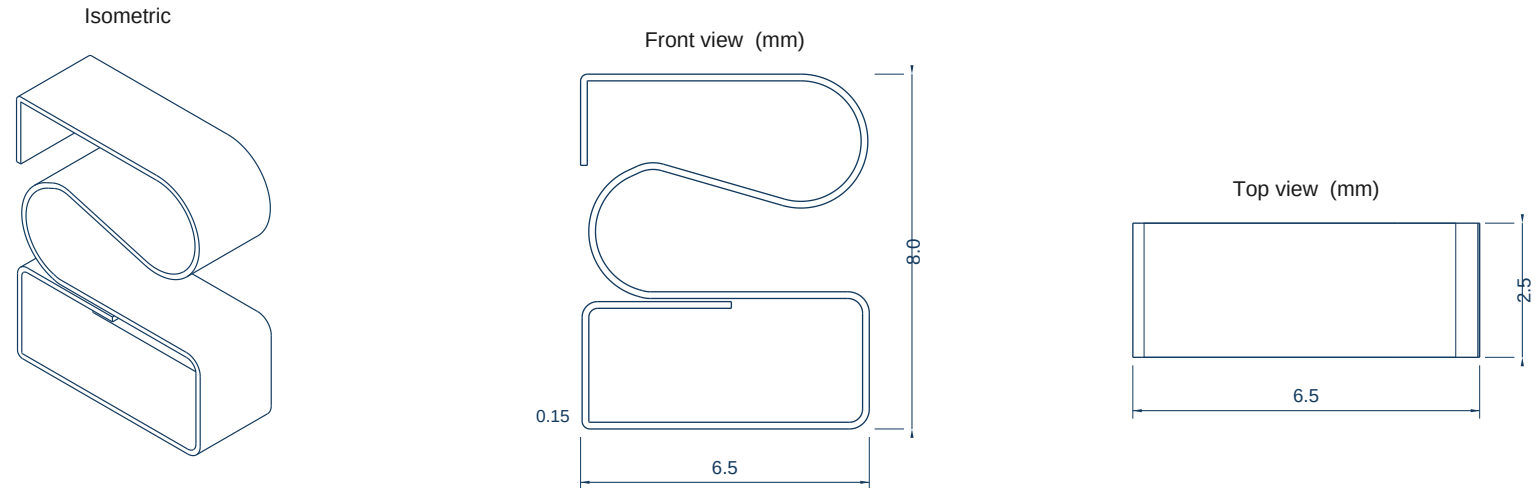




Type S-01 BS01-25065080

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL	VALUE
Thickness	0.15 mm
Width	2.5 mm +/- 0.2
Length	6.5 mm +/- 0.2
Height	8.0 mm +/- 0.2
Form	closed box base + S-spring, top arm with return tab
Top curl	R1.424 CL, 196 deg
S upper bend	R0.774 CL, 41 deg
S lower bend	R1.430 CL, 139 deg
Box corners	R0.405 / 0.371 / 0.100 / 0.275 CL, 90 deg
Developed length	38.50 mm
Material / plating	BeCu, Gold-plated (G)
Volume / mass	14.373 mm ³ 120.2 mg (BeCu)
File format	STEP AP214

PRODUCT DATA	VALUE
Mfr P/N	BS01-25065080G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 6.5x2.5x8.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-s-01.html